

JLC Detector Overview

Nov. 1. 2001
@4th ACFA LC Meeting

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Contents:

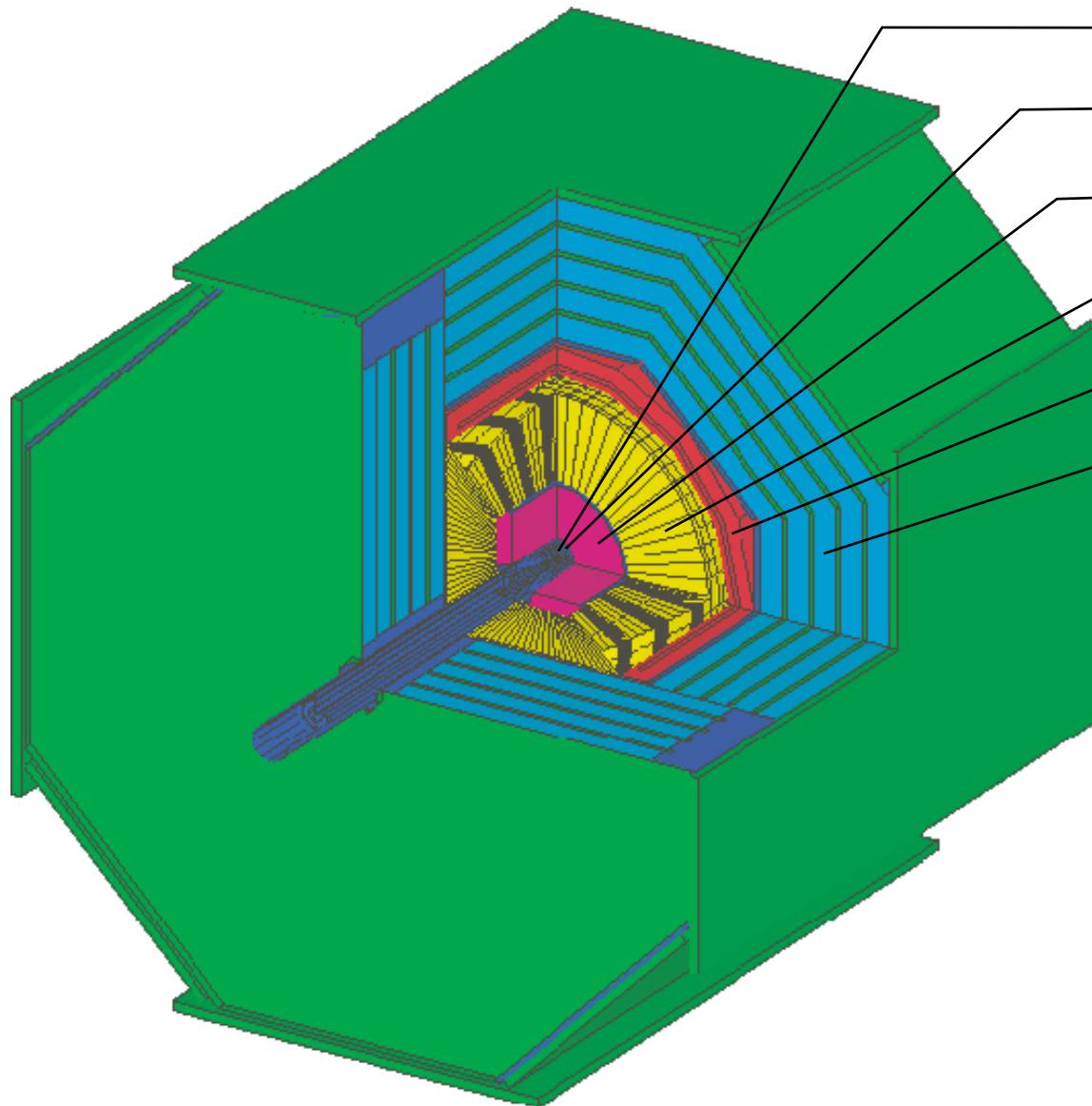
R&D Status and Plan

- CCD Vertex Detector
- Central Drift Chamber
- Calorimeter

Machine Design and Detector Design

- Mask System
- New F.F. Optics

JLC Detector Model



Barrel Region

Vertex Detector

Intermediate Tracker

Central Drift Chamber

Calorimeter

Superconducting Solenoid

Iron Structure / Muon Tracker

(Particle ID ?)

Forward Region

(Forward Silicon Tracker)

Active Mask

Luminosity Monitor

Pair Monitor

Parameters of the JLC Detector Model

Detector	Configuration	Performances	Channels and Data Size
PM (3D Active Pixel)	$\theta = 11 - 48\text{mrad}$ ($r=2\text{-}8.5\text{cm}$) 300 μm -thick x 2 layers pixel size=100 μm	Under Study	Number of pixels = 8.6M Readout channel = 156ch Data size = 12k bytes/sec
LM (W/Si)	$\theta = 50\text{-}150\text{mrad}$ 43X0 x 16samplings $Nr = 32$, $N\phi = 16$	Under Study	Number of pads = 16.4k Readout channel = 128ch Data size = 3.3k bytes/train
AM (W/Si)	$\theta = 150\text{-}200\text{mrad}$ 23X0 x 8samplings $Nr = 10$, $N\phi = 32$	Under Study	Number of pads = 5.1k Readout channel = 16 Data size = 5.1k bytes/train
FT	TBD	Unknown	
VTX (CCD)	$\cos\theta < 0.90$ pixel size=25 μm , thickness=300 μm 4 layers at $r = 2.4$, 3.6, 4.8, 6.0cm	$\sigma = 4.0\mu\text{m}$ $\delta^2 = 72 + (20/p)^2/\sin^3\theta$ [μm] $\mathbf{\Theta_B=50\% @ purity=93\%}$	Number of pixels = 320M Readout channel = 2.4k Data size = 1.4M bytes/train
IT (Si-strip)	$\cos\theta < 0.90$ strip width=100 μm , thickness=300 μm 5 layers at $r = 9$, 16, 23, 30, 37cm	$\sigma = 4.0\mu\text{m}$ Tracking Performance Under Study	Number of strips = 522k Readout channel = 1.0k Data size = under study
CDC (Mini-jet)	$\cos\theta < 0.70$ (full sample) $\cos\theta < 0.95$ (1/5 samples)	$\sigma_z = 1\text{ mm}$ 2-track separation = 2mm	200MHz FADC depth = 1k words
2Tesla	$r = 45 - 230\text{cm}$, $L = 460\text{cm}$ $N_{sample} = 80$	$\sigma_x = 100\mu\text{m}$ $\sigma_{Pt} / Pt = 1 \times 10^{-4} \text{Pt} + 0.1\%$	Readout channel = 13k Data size = 5.2M bytes/train
3Tesla	$r = 45 - 155\text{cm}$, $L = 310\text{cm}$ $N_{sample} = 50$	$\sigma_x = 8.5\mu\text{m}$ $\sigma_{Pt} / Pt = 3 \times 10^{-4} \text{Pt} + 0.1\%$	Readout channel = 8.1k Data size = 3.3M bytes/train
Trackers Combined		$\sigma_{Pt} / Pt = 1 \times 10^{-4} \text{Pt} + 0.1\%$	
CAL (Pb/Sci)	EM = 27X0 (3sections) HAD = 6.5λ0 (4sections) $\Delta\theta, \phi = 24\text{mrad}$ (EM), 72mrad (HAD)	$\sigma/E = 15\%/\sqrt{E+1}\%$ (EM) $\sigma/E = 40\%/\sqrt{E+2}\%$ (Had) $e/\pi \text{ ID} = 1/10\,000$	Number of cells = 144k Readout channel = 5k Data size = 3k bytes/train
2Tesla	$\cos\theta < 0.985$ (full thickness) $r = 250 - 400\text{ cm}$, $z = +- 290\text{cm}$		
3Tesla	$\cos\theta < 0.966$ (full thickness) $r = 160 - 340\text{ cm}$, $z = +- 190\text{cm}$		
SHmax	scin.strip (1cm-wide) or Si-pad (1cm x 1cm)	$\sigma = 3\text{mm}/\sqrt{E}$	Readout channel = 5k Data size = 40k bytes/train
MU (SWDC/RPC/TGC)	$\cos\theta < 0.998$ 6 SuperLayers	$\sigma = 0.5\text{mm}$	Readout channel = 10k Data size = Muon ID under study
Yoke	2Tesla $r = 5.5\text{m} - 7.5\text{m}$, $Z = 5.0\text{m} - 7.9\text{m}$		
3Tesla	$r = 4.5\text{m} - 7.0\text{m}$, $Z = 3.9\text{m} - 6.5\text{m}$		

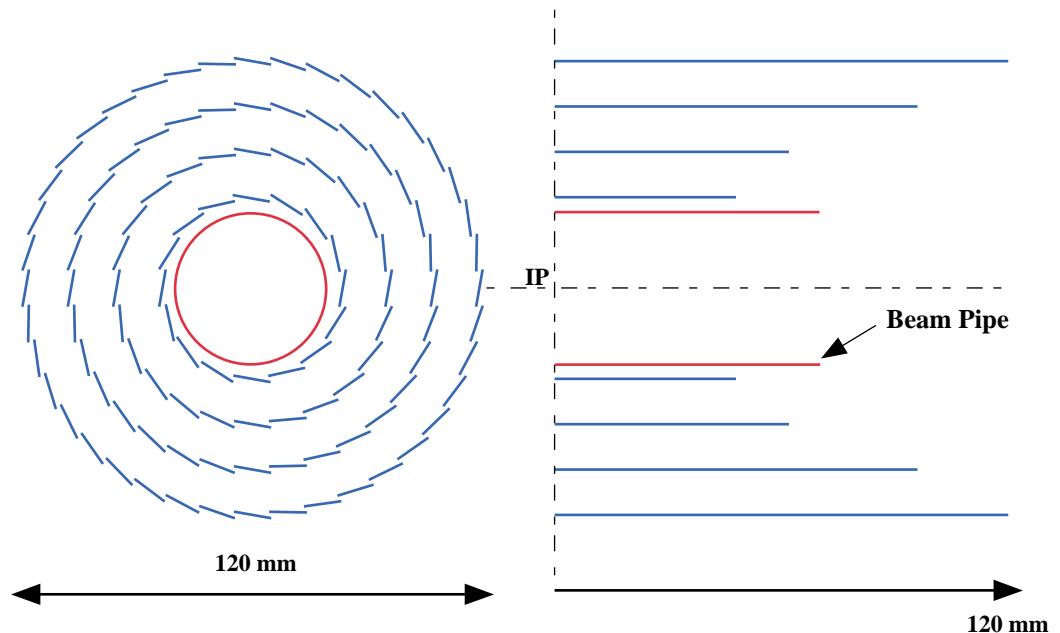
R&D Status of Sub-detector Components for JLC

- Vertex Detector**
- Central Drift Chamber**
- Calorimeter**

Vertex Detector

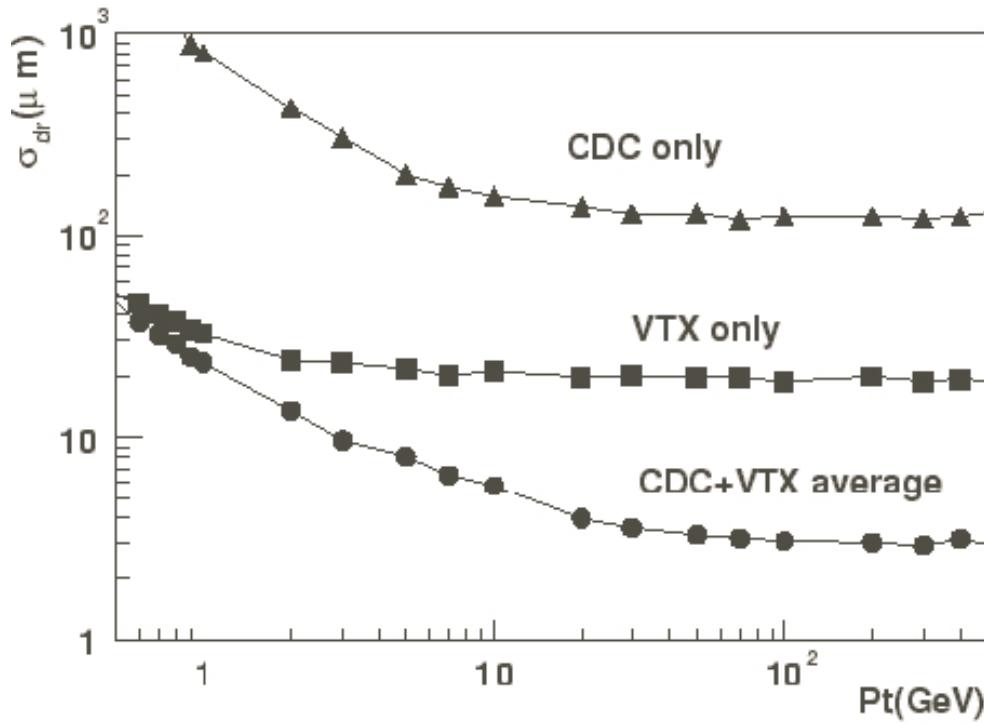
Present Design Parameters in JIM (JLC full Simulator)

- 4 layers of CCDs at $r = 24, 36, 48, 60$ mm
--Another layer at smaller r ?
- Angular coverage of $|\cos\theta| < 0.9$
- Wafer thickness of 300 μm
-- Thinner wafer ?
- Pixel size of 25 μm^2
- $\sigma = 4 \mu\text{m}$
- $\delta^2 = 7^2 + (20/p)^2 / \sin^3\theta \ [\mu\text{m}]$

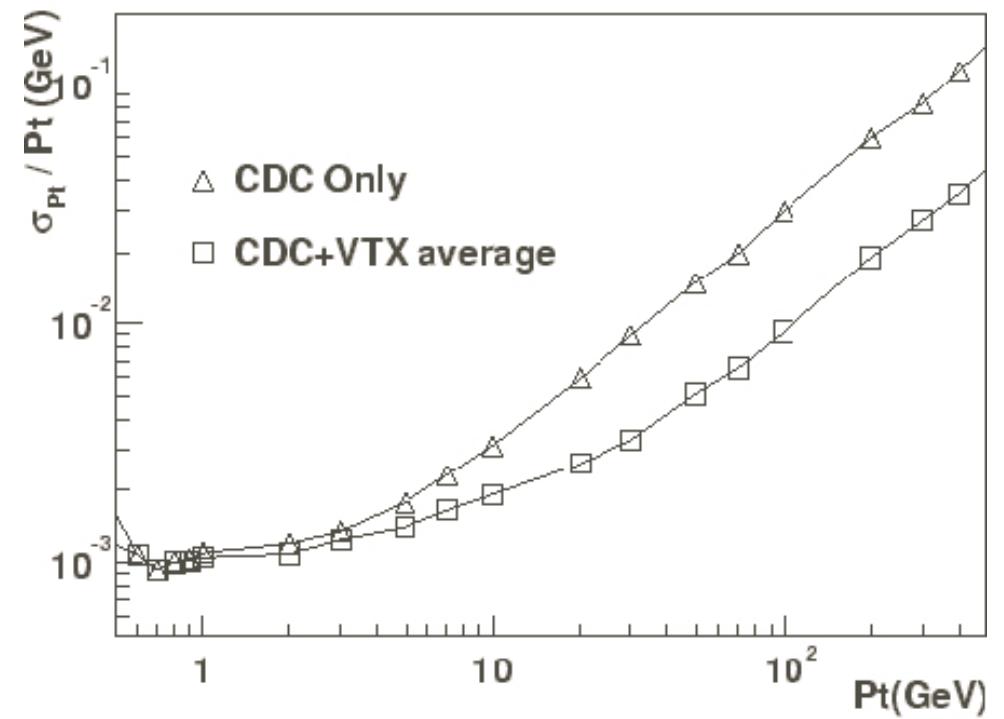


Expected Performance of CCD Vertex Detector

Impact parameter (2D) resolution



Momentum resolution



Better than 7 μm expected by VTX alone at large P_t
due to high resolution **CDC**

$$\sigma_b = \frac{\sigma_{in} r_{out}}{r_{out} - r_{in}} \oplus \frac{\sigma_{out} r_{in}}{r_{out} - r_{in}} \oplus \frac{0.014 r_{in}}{p\beta} \sqrt{\frac{X_r}{\sin^3 \theta}}$$

R&D Status & Plan of CCD Vertex Detector

1) Spatial resolution

- Resolution of $<3\mu\text{m}$ has been confirmed with test beam
- Laser beam (1064 nm) scanner with $2\mu\text{m}$ spot size (Niigata Univ.)

2) Study of distortion of CCD wafers

Thinner wafer is desirable

--- 20 μm is enough for particle detection

--- but how to support?

Thermal distortion shoud be reasonably small
and has repeatability

Idea of C.Damerell's group: 50 μm wafer stretched from both ends

-> proposed in TESLA TDR

Another idea: Partially thinned wafer like SHOJI in traditional Japanese house

System of distortion measurement has been constructed

3) CCD radiation hardness

The result of our study so far using ^{90}Sr irradiation is;

CCD can survive > 3 years with

$$\mathbf{B} \quad = \quad \mathbf{2T}$$

$$\mathbf{R_{min}} \quad = \quad \mathbf{24 \text{ mm}}$$

Machine parameter "A" (Standard Luminosity)

But it is preferable to have

$$\mathbf{R_{min}} \quad < \quad \mathbf{24 \text{ mm}}$$

High Luminosity ("Y") Option

-> **Study of radiation hardness should be continued**

Issues to be studied:

- Effect of readout speed

-> **Fast readout (~10MHz) is needed**

- How to inject the “Fat Zero Charge”

- Radiation damage effect on the spatial resolution

-> @Niigata Univ.

- Radiation damage by high energy (>10MeV) electrons

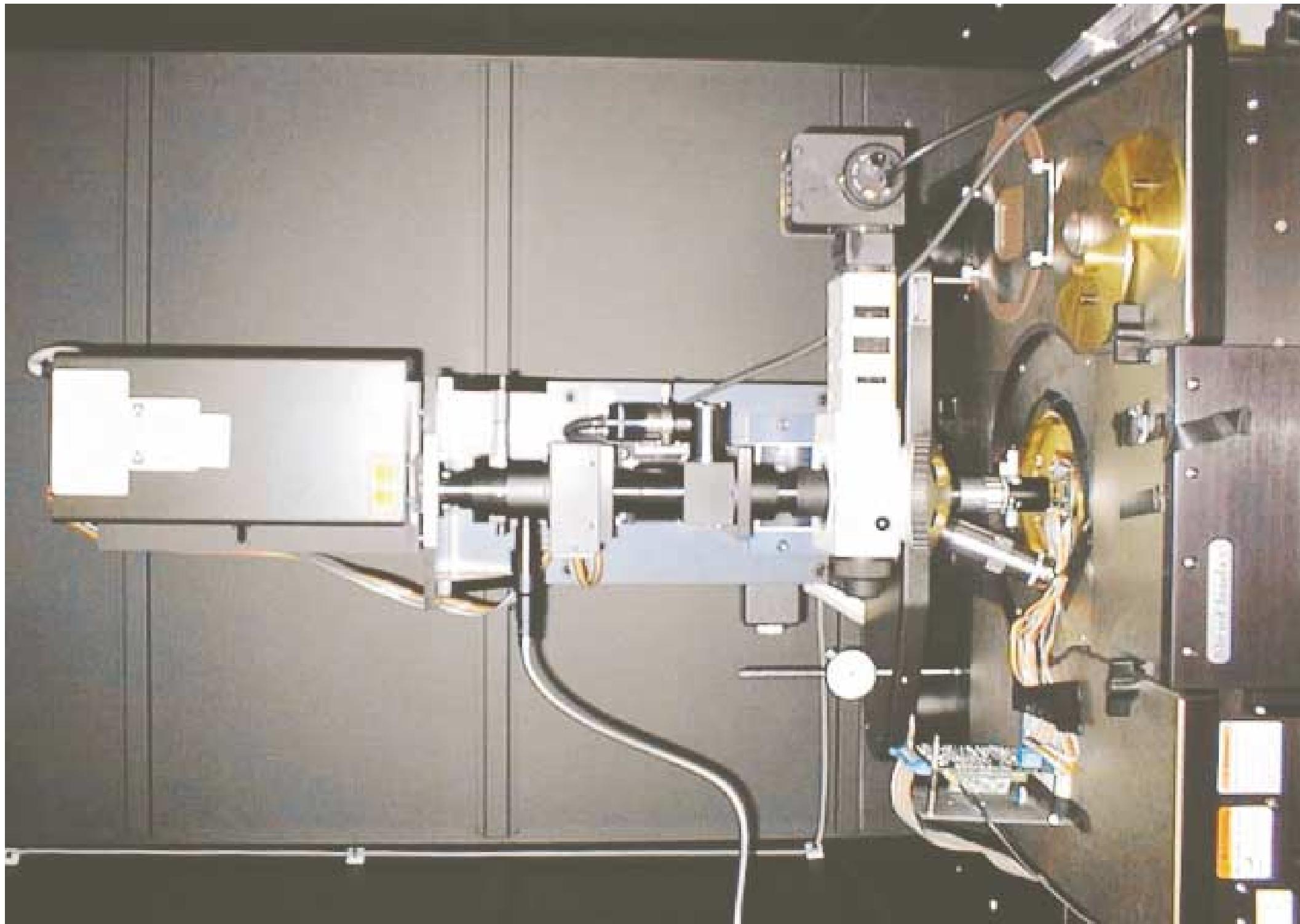
-> **Sooner or later**

4) Fast readout electronics

CCD Signal Processor chip for Digi-Cam

- Correlated double sampler
- Variable gain amp
- 10bit/40MHz or 12bit/20MHz ADC

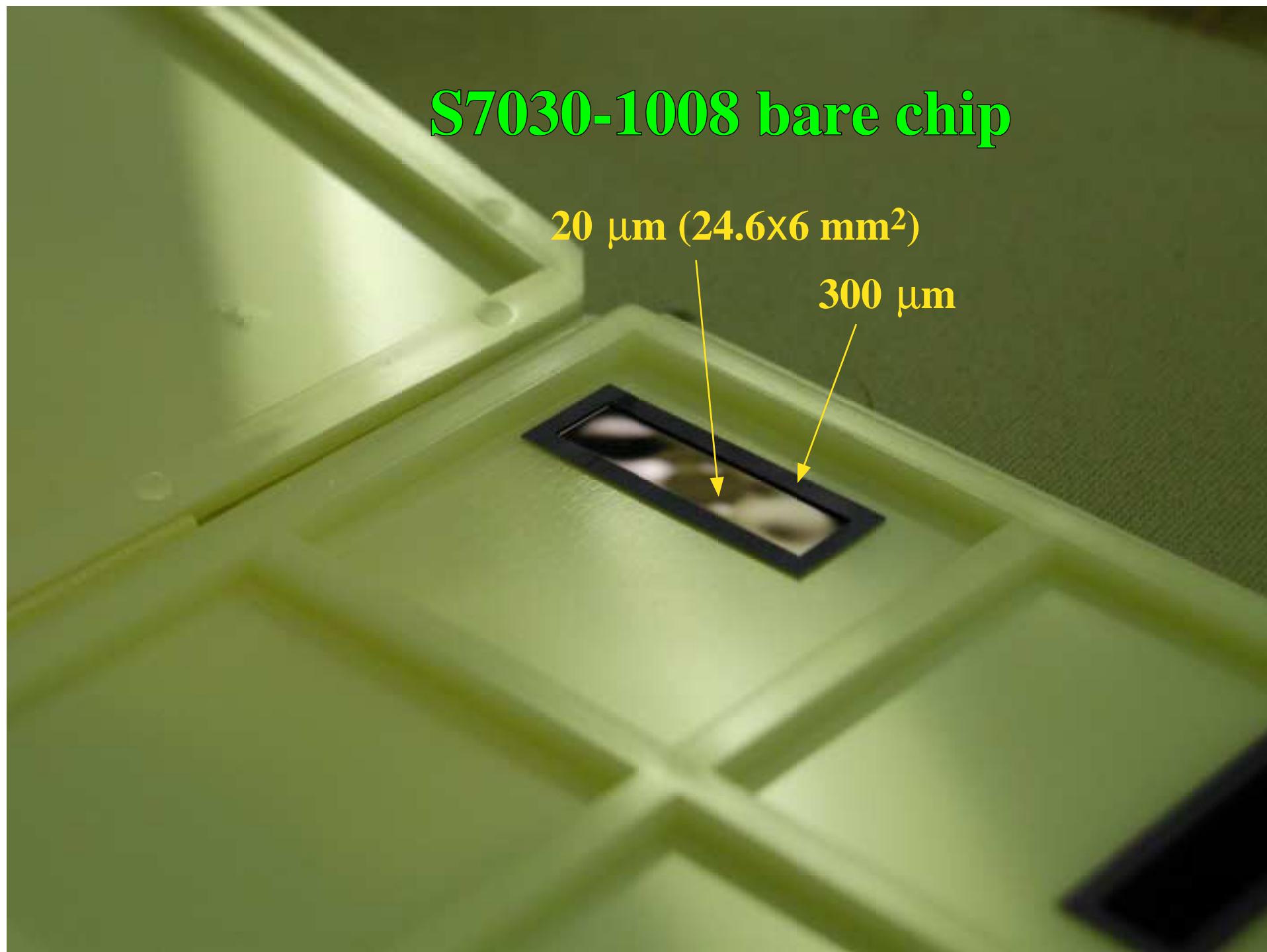
These functions in 9x9 mm² chip size by \$6/chip



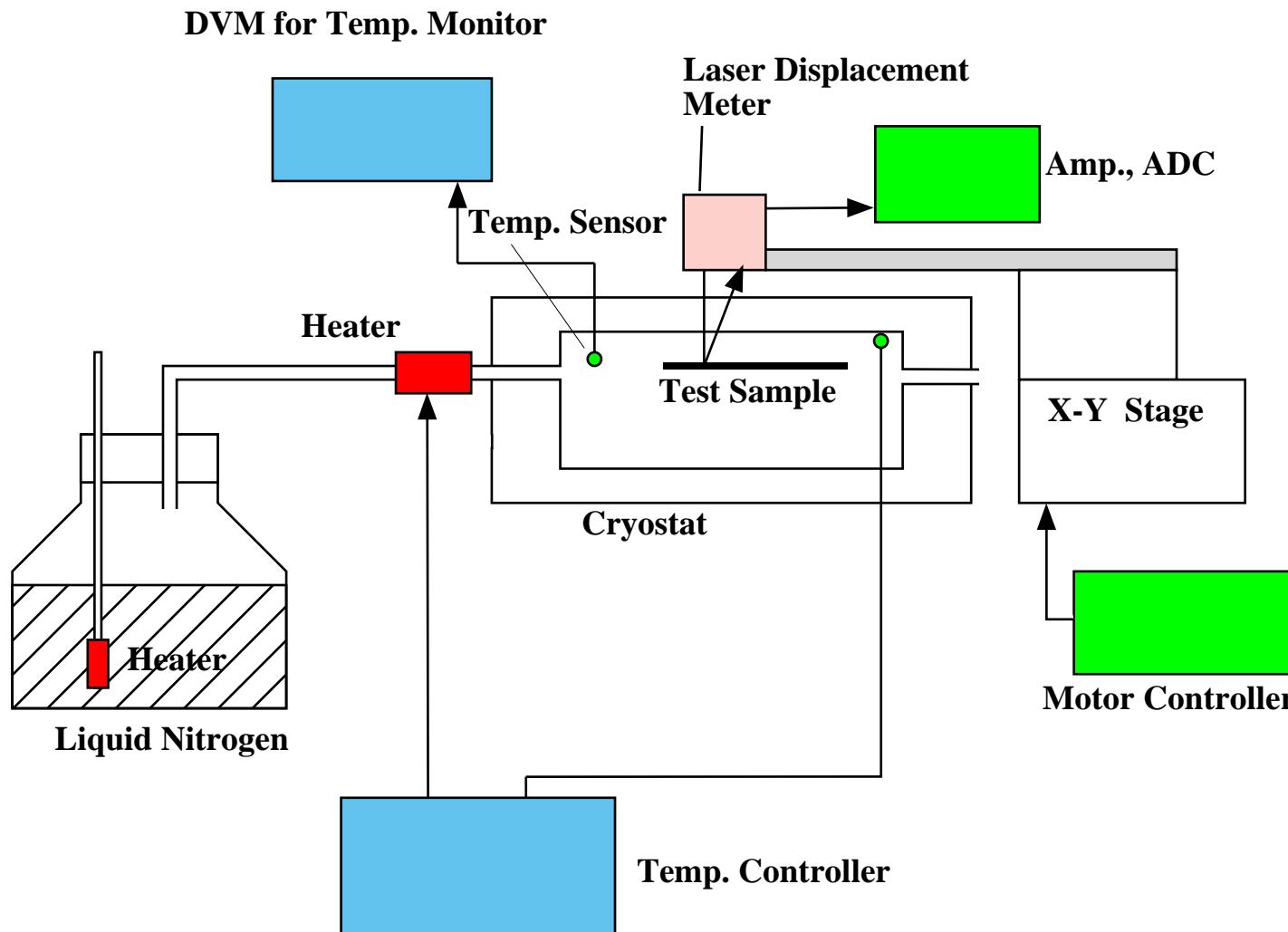
S7030-1008 bare chip

20 μm (24.6x6 mm^2)

300 μm

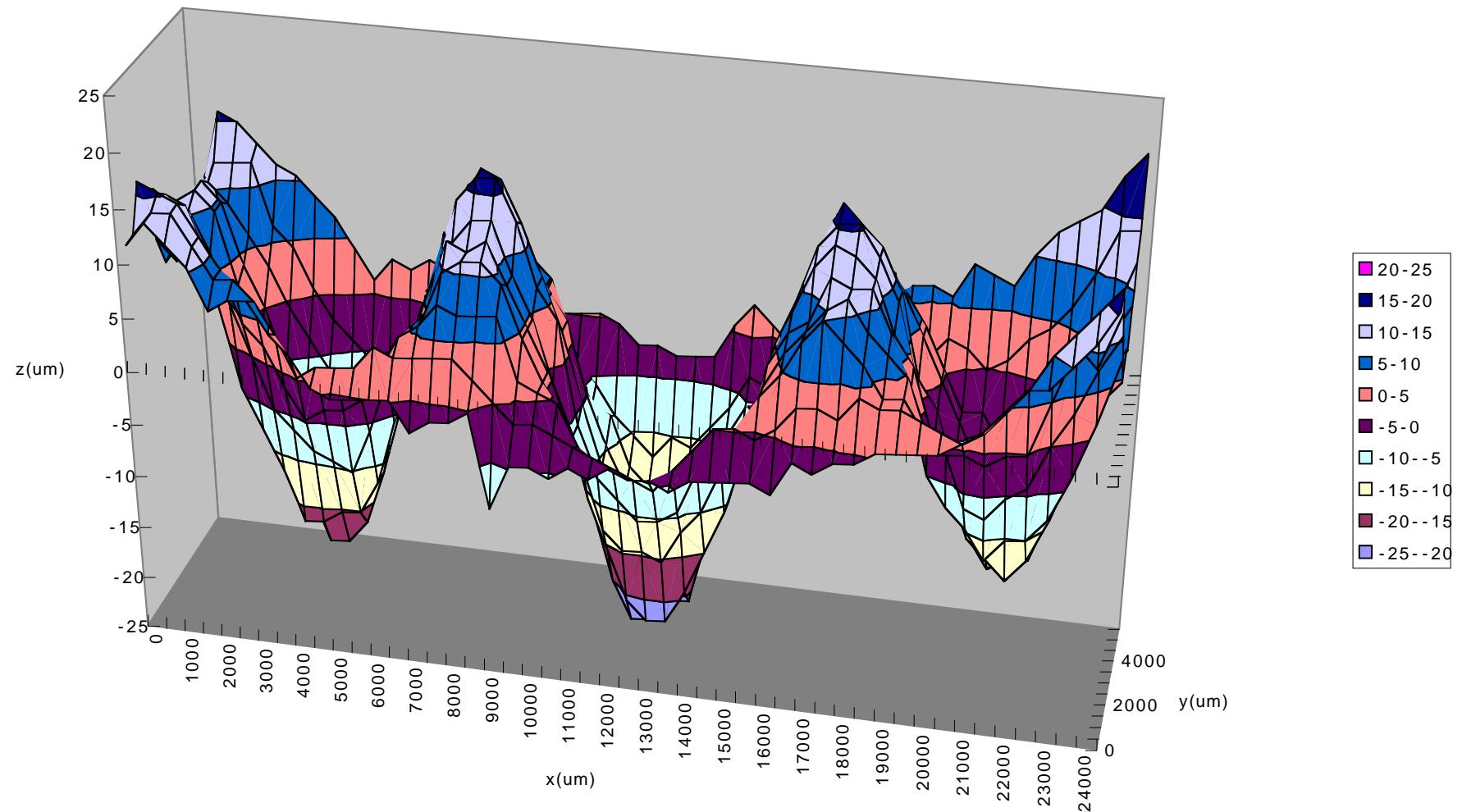


Measurement System



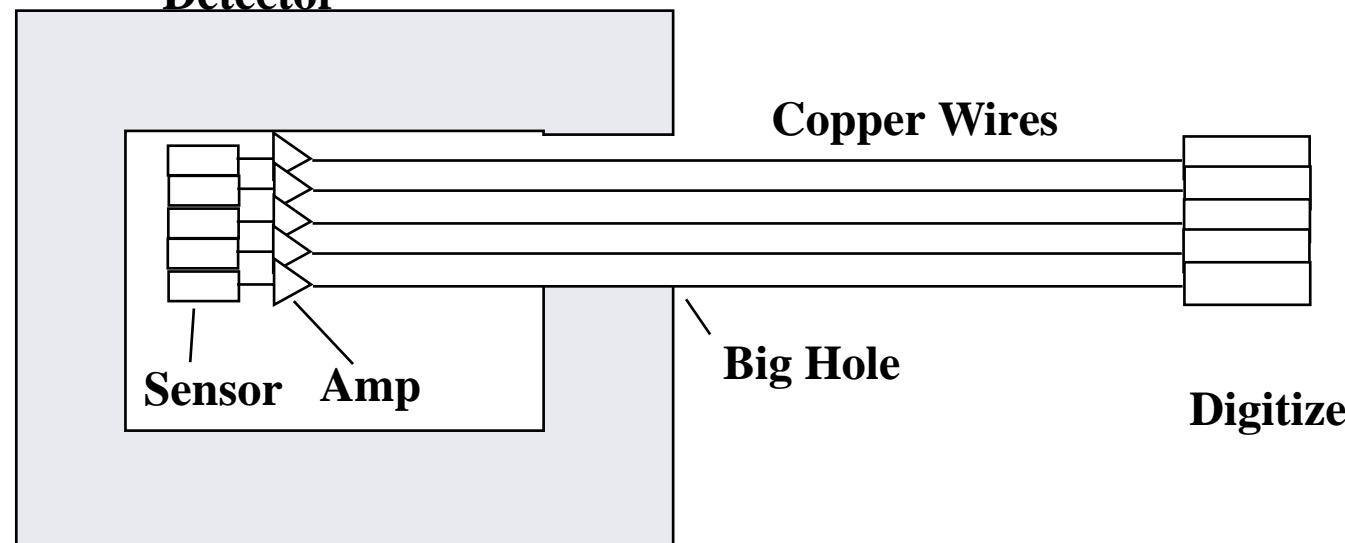


S7030 (27deg)



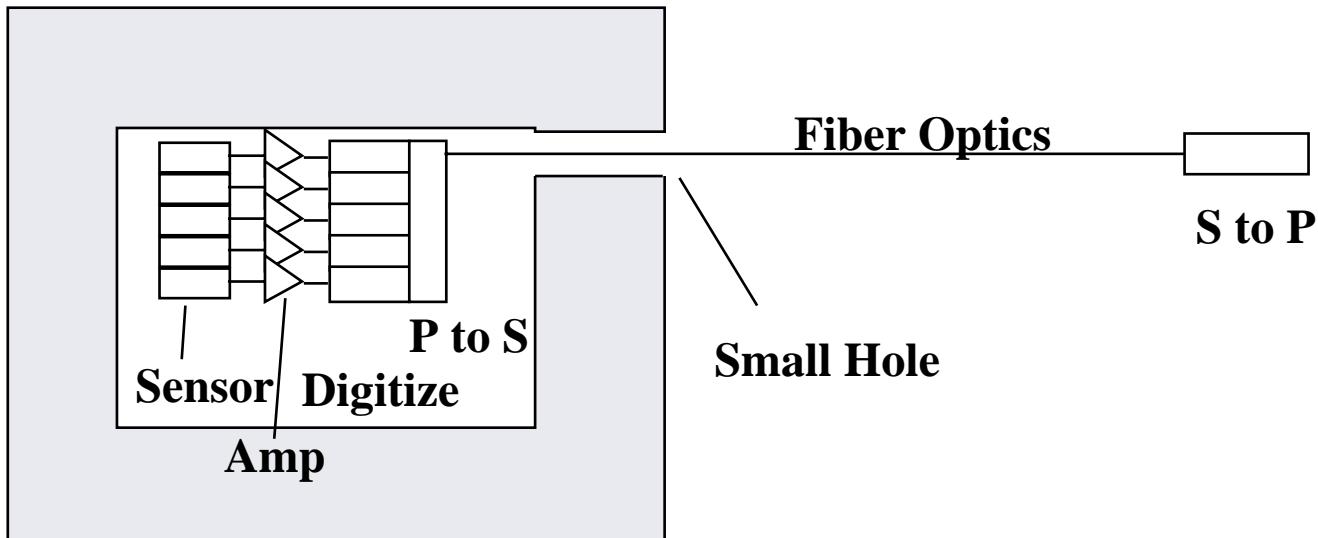
Detector

Old Fashioned



Detector

Advanced (SLD~)



	SLD (VTX3)	JLC
# of pixels	307 M	> 320 M
Readout time	200 ms	6 ms
R.O. frequency	5 MHz	20 (40) MHz
# of r.o. ch	384	> 2600 (1300)
Throughput	15 Gbps	> 500 Gbps
Fiber Optics	960Mbps x 16	3.4 Gbps (IEEE1394b) x 150 ??

Current CDC Parameters (R&D)

Mini-jet cell structure (5 anode wires /cell)

Gas mixture CO₂(90%) – C₄H₁₀(10%)

$\sigma_{xy} = 85 \mu\text{m}$

2-Tesla option

$R_{in} = 45 \text{ cm}$

$R_{out} = 230 \text{ cm}$

$L = 460 \text{ cm}$ (Length of the chamber)

$B = 2 \text{ T}$

$n = 80$ (Number of sampling points)

3-Tesla option

$R_{in} = 45 \text{ cm}$

$R_{out} = 155 \text{ cm}$

$L = 310 \text{ cm}$ (Length of the chamber)

$B = 3 \text{ T}$

$n = 50$ (Number of sampling points)

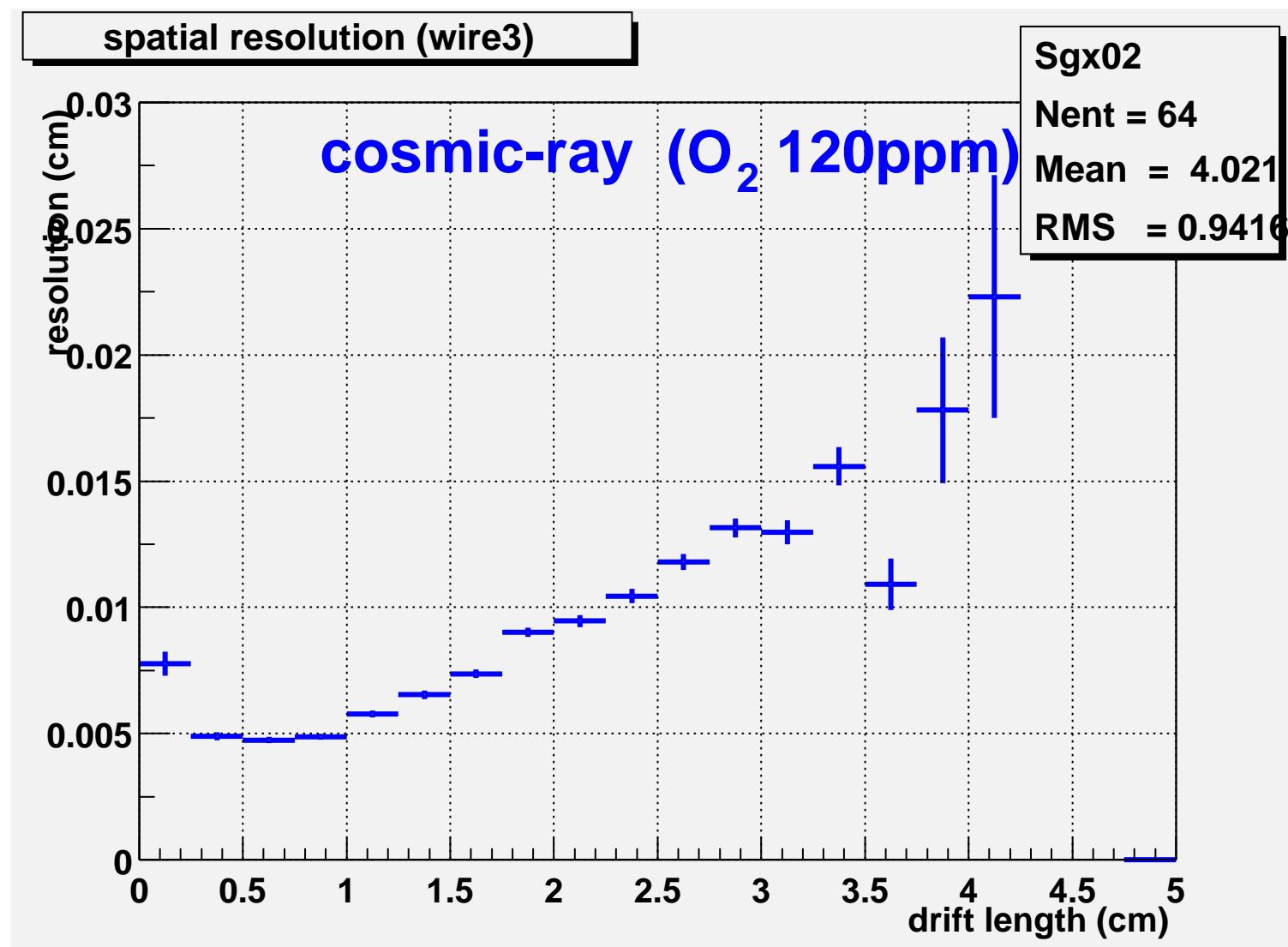
Progress after last ACFA meeting

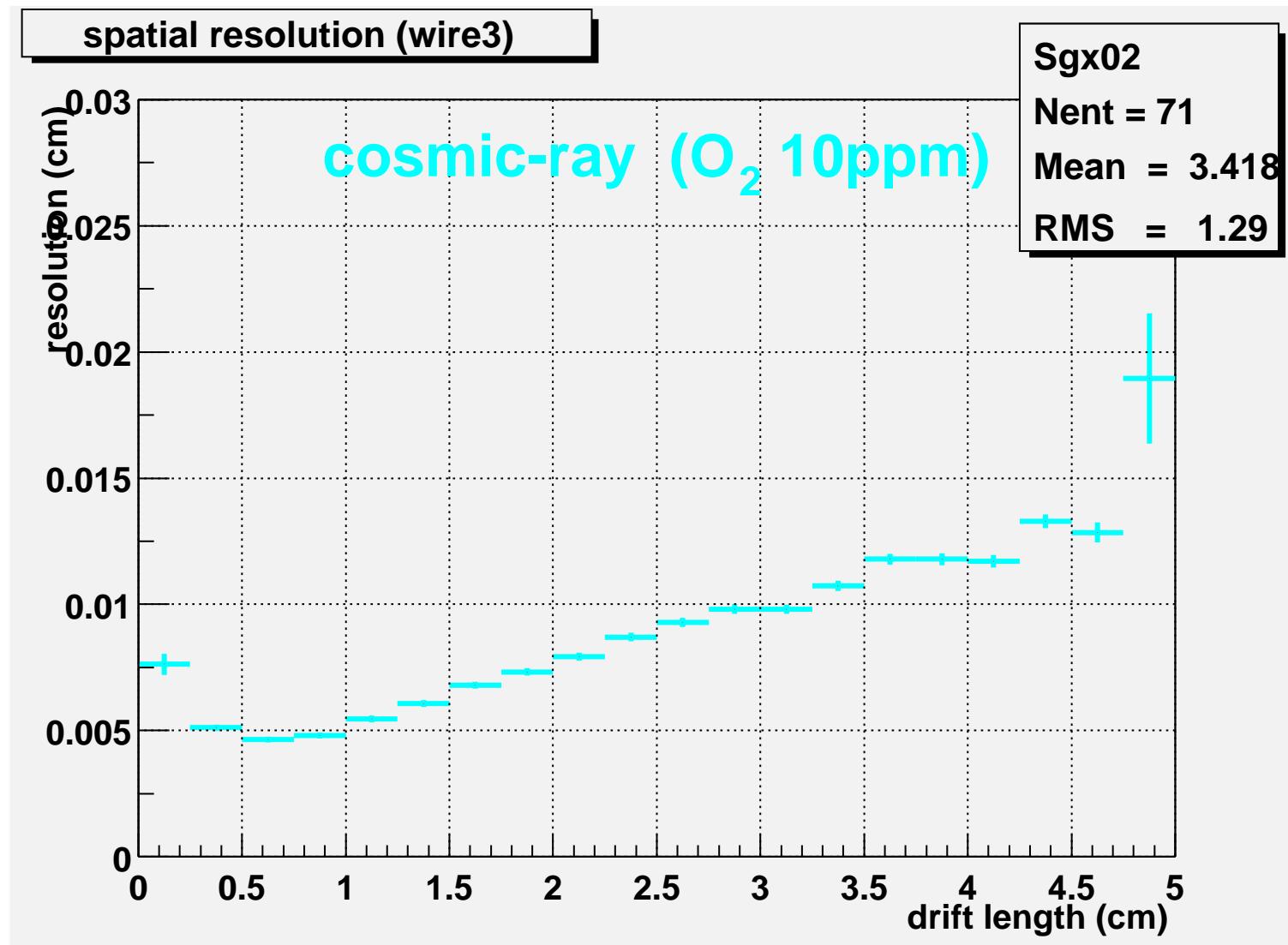
Past

- Gas Gain Measurement ...
NIM, A447 (2000) 459.
- Lorentz Angle Measurement ...
Subm. to NIM.

Present status and future plan

- dE/dx Measurement ...
Draft – in preparation.
- Oxygen Contamination Study ...
Draft – in preparation.
- Single Track Study (space resolution etc.) ...
Draft – in preparation.
- Space charge effect study...
in progress.
- Two-track separation study ...
in progress.
- Signal shape study (GARFIELD, experiment) ...
in progress.
- Wire material study (tension problem) ...
in progress.
- GEANT4 development (3T option) ...
in progress.
- Neutron background study ...





Calorimeter

Baseline Design

- **Structure : Lead/Plastic scintillator Sandwich**
EM : Pb/Sci=4mm/1mm
had : Pb/Sci=8mm/2mm
- **Scheme : Tile/Fiber**

with hardware compensation

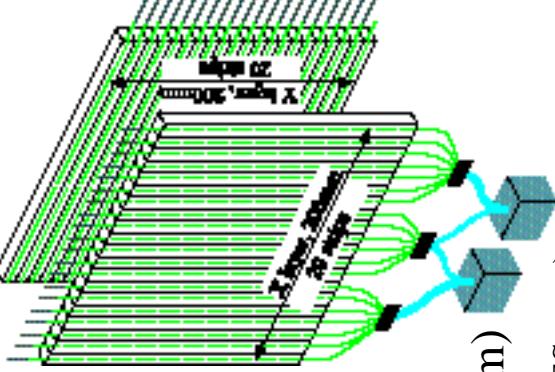
- Granularity : as small as reasonably achievable...under study

Baseline Rect-Tile

EM : 4cm x 4cm (24mrad) x 3 longitudinal samplings
had : 14cmx14cm (72mrad) x 4 longitudinal samplings

Strip-EM option

1cm-wide strip-array (x-y layers) x ~20 longitudinal samplings



- Shower Max Detector
Baseline : 1cm-wide strip-array (x-y layers)
Option : 1cm x 1cm Si-pad

Performances

- Single-particle response (measured with testbeam)
 $E/E = 15.4\% / E + 0.2\%$ for electrons (ZUES-type)
 $E/E = 46.7\% / E + 0.9\%$ for pions
 $x = 2 \sim 3\text{mm}$ even at over 50GeV
pion rejection = 1/1400 at $e = 98\%$
- **Jet response : under simulation study**

Recent Activities

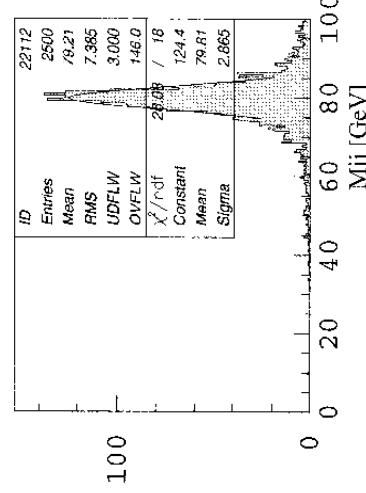
[I] Granularity Optimization with Full Simulation

Analysis of quick-simulation data gives very good performance

... but it is not the end of the story.

1) Construction of full-simulator

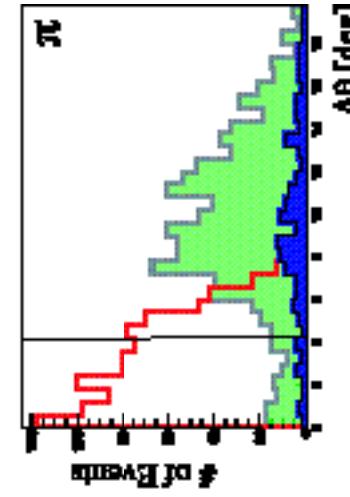
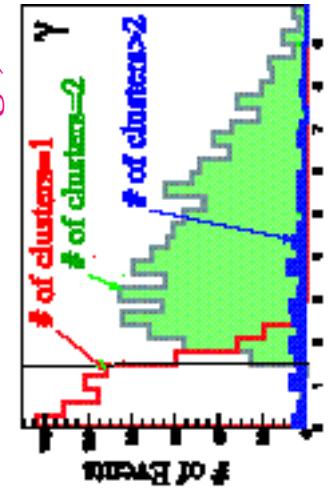
- Done for baseline design (Rect-Tile).
- not yet for optionl design (strip-EM).



2) Shower clustering ; in progress but very difficult

a) hadron shower clustering

- <--- • 2D-JADE ; not successful yet
- 2D-contiguous ; not successful yet
- 3D-contiguous ; not successful yet
- **Super-cluster = French method**
- **not yet tried (below)**

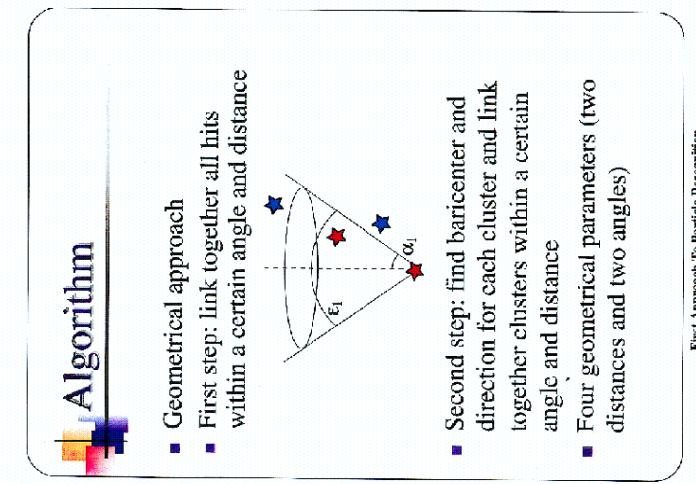


b) decomposition of overlapping showers

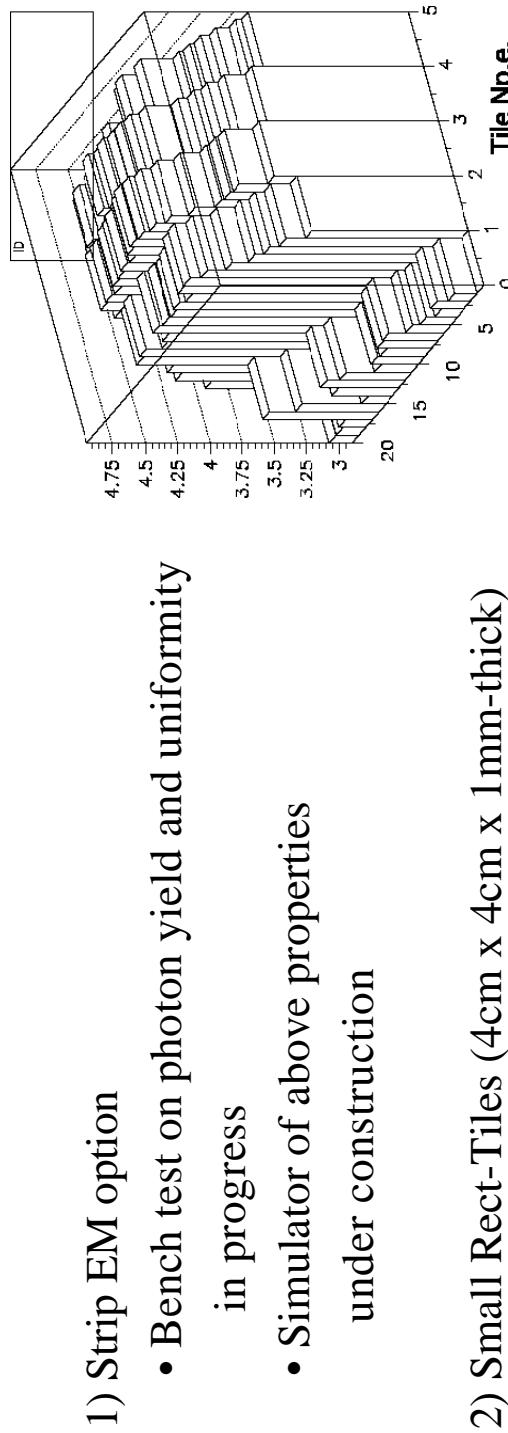
under study including its necessity itself

c) track-cluster association

under study including 1st principle ;
whether **one-to-one** or plural-to-one



[III] Hardware Studies

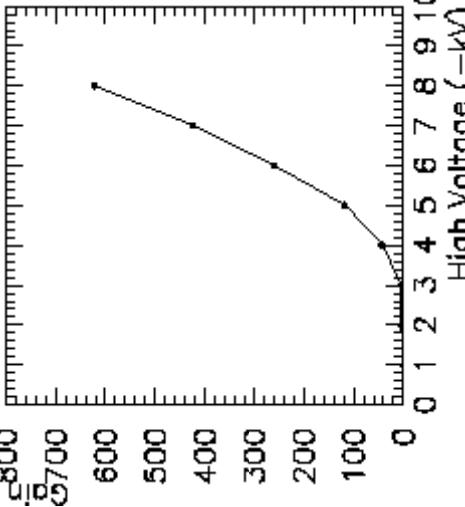


3) Direct-readout SHmax ; Bench test in progress

- PIN-Si ; gain too low
- APD ; under study ... might be operational but costly

4) Photon Detectors

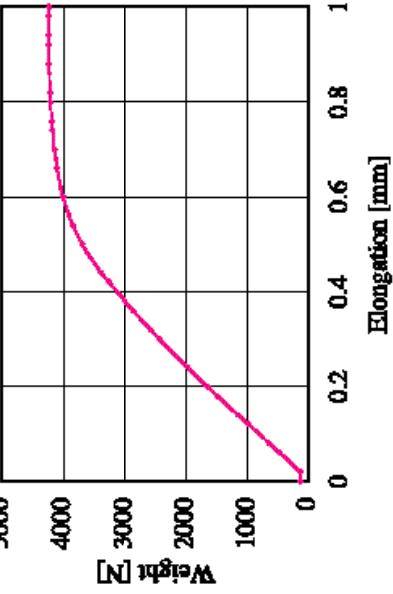
- Multi-channel HPD ; toward SinglePhotonPeak
- Single-channel HAPD ; toward multi-ch
- **EBCCD ; toward High Gain**
- **High-QE photo-cathode (40% @540nm)**
- <--> WLS die optimization for Rect-Tile



5) Lead Alloy

a) Measurement of Strength and Young modulus in progress

- dopants ; Sb, Ca/Sn ... in progress
- As ... hopeful but difficult
- treatment ; heat / mechanical



b) Hybrid material

Paper-work in progress

Coming R&D plans

1) Further full-simulation studies on granularity optimization

2) Beam tests of fine-granularity EM module

includes

- Strip-EMC
- Rect-Tile EMC
- Direct-readout SHmax
- Optimum photon detectors for each

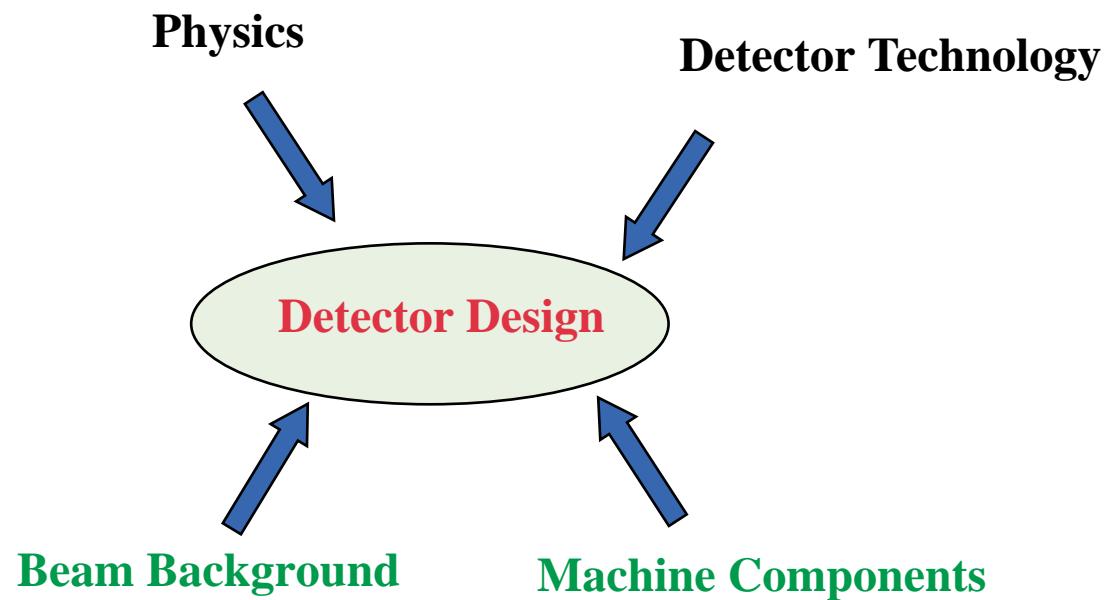
3) Lead alloy and structures

- Further studies on alloys and hybrid materials
Make test pieces of SUS-Pb sandwich
- Engineering studies on structure

4) Mass production of tiles and fiber assemblies

- Tiles ; Design optimization for "moldable" tiles
MEGA-tile structure, groove cross section, etc.
- Fiber assemblies ; low-cost heat-splicing, mirroring, etc.

Machine Design and Detector Design



Trend of the JLC Detector Model

2 Tesla Solenoid Magnet (JLC-I)



3 Tesla Solenoid Magnet (ACFA Report)

- Less beam background hits
- Smaller detector (CDC) size

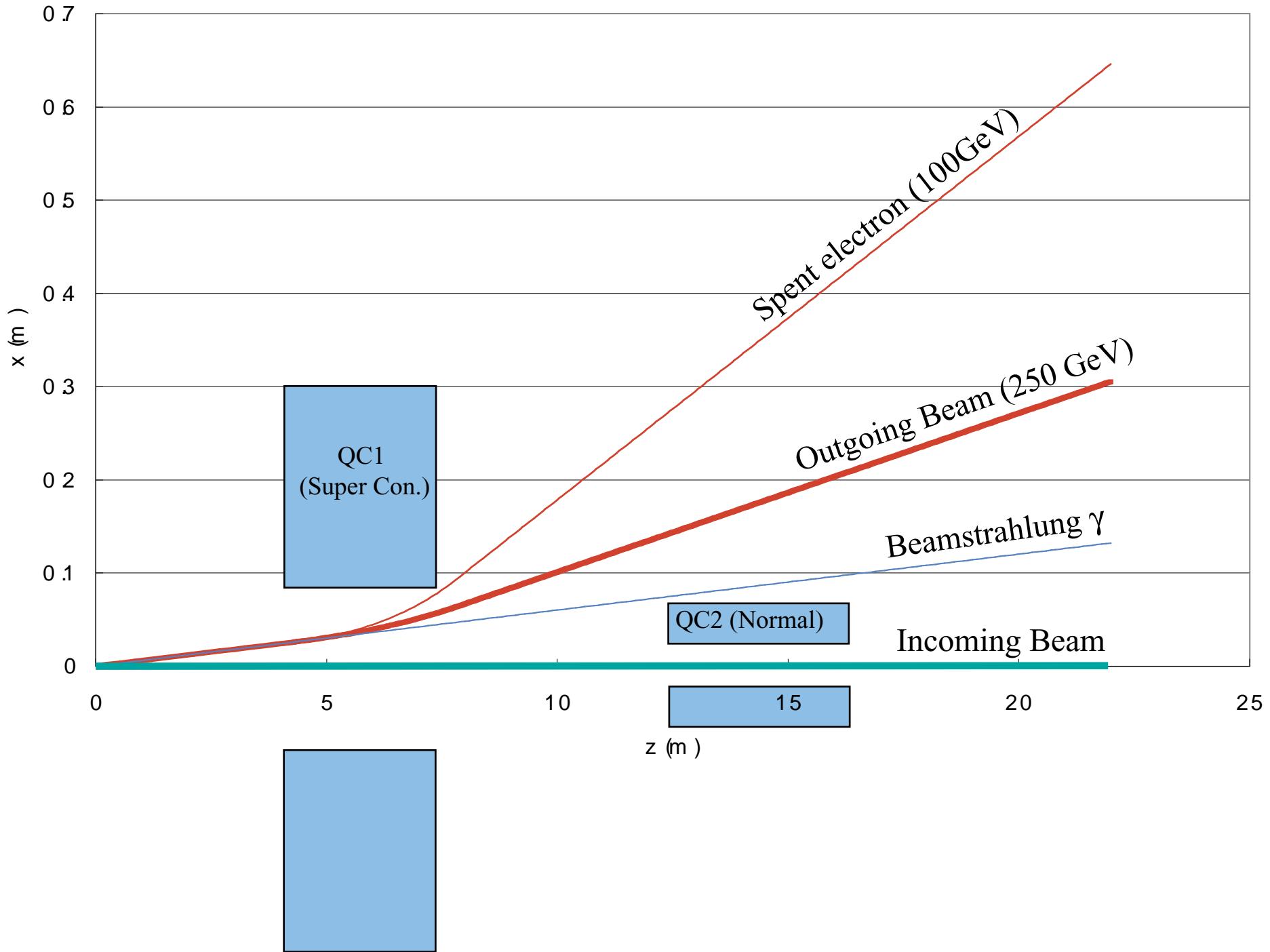


4 m l^* -- New Final Focus Optics

- Still less beam background hits
- Smaller inner radius for CDC & ECAL
- Better forward coverage

New Final Focus Optics

- Proposed by Pantaleo Raimondi & Andrei Seryi (SLAC)
- Length of the final focus section : 1800 m -> 500 m @ $E_b=500\text{ GeV}$
- l^* (distance between IP and QC1) : 2 m -> 4.3 m
- Optimization for JLC has to be done
- Estimation of beam background (sync. rad. etc.) needed



Detector models and Mask system

Detector Model	QC1 surrounded by	Mask System
Old $B=2T$ $l^*=2m$	CDC	Long tungsten(W) mask inside support tube Low-Z (graphite/CH ₂) mask in front of QC1
Now $B=3T$ $l^*=2m$	CAL	Long W Mask inside Support Tube (Short W mask is enough) Low-Z mask
Future $B=3T$ $l^*=4.3m$	Endcap Iron	Forward calorimeters (No W mask) Low-Z mask

Simulation

Generation of pair background:

CAIN

Ebeam=250GeV

"A" option ("Y" option)

Detector Simulation:

JIM (based on GEANT3)

Ecut for γ : 10 keV

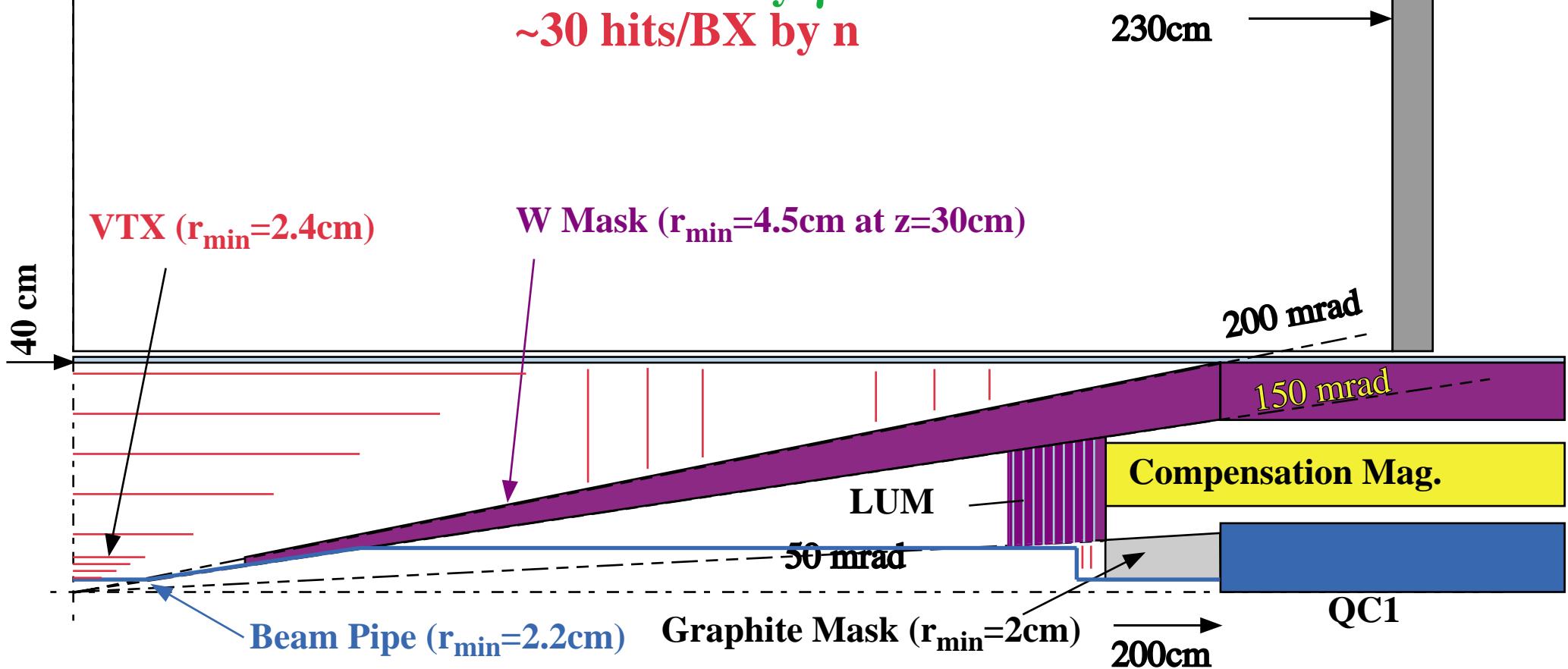
Ecut for n: 1 keV

B field of compensation mag. & QC included

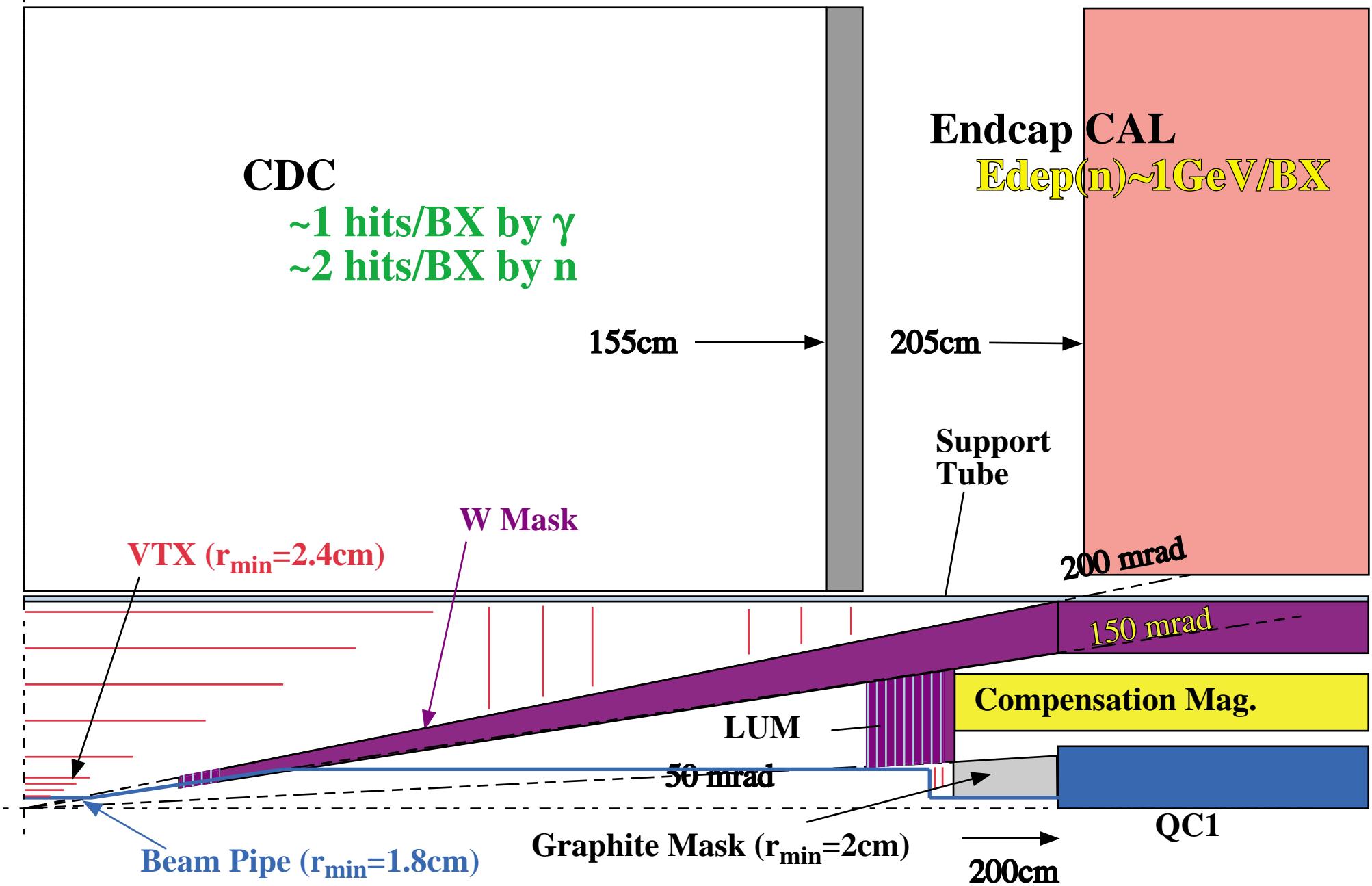
2T Detector

CDC ($\text{CO}_2\text{-IsoC}_4\text{H}_{10}$)

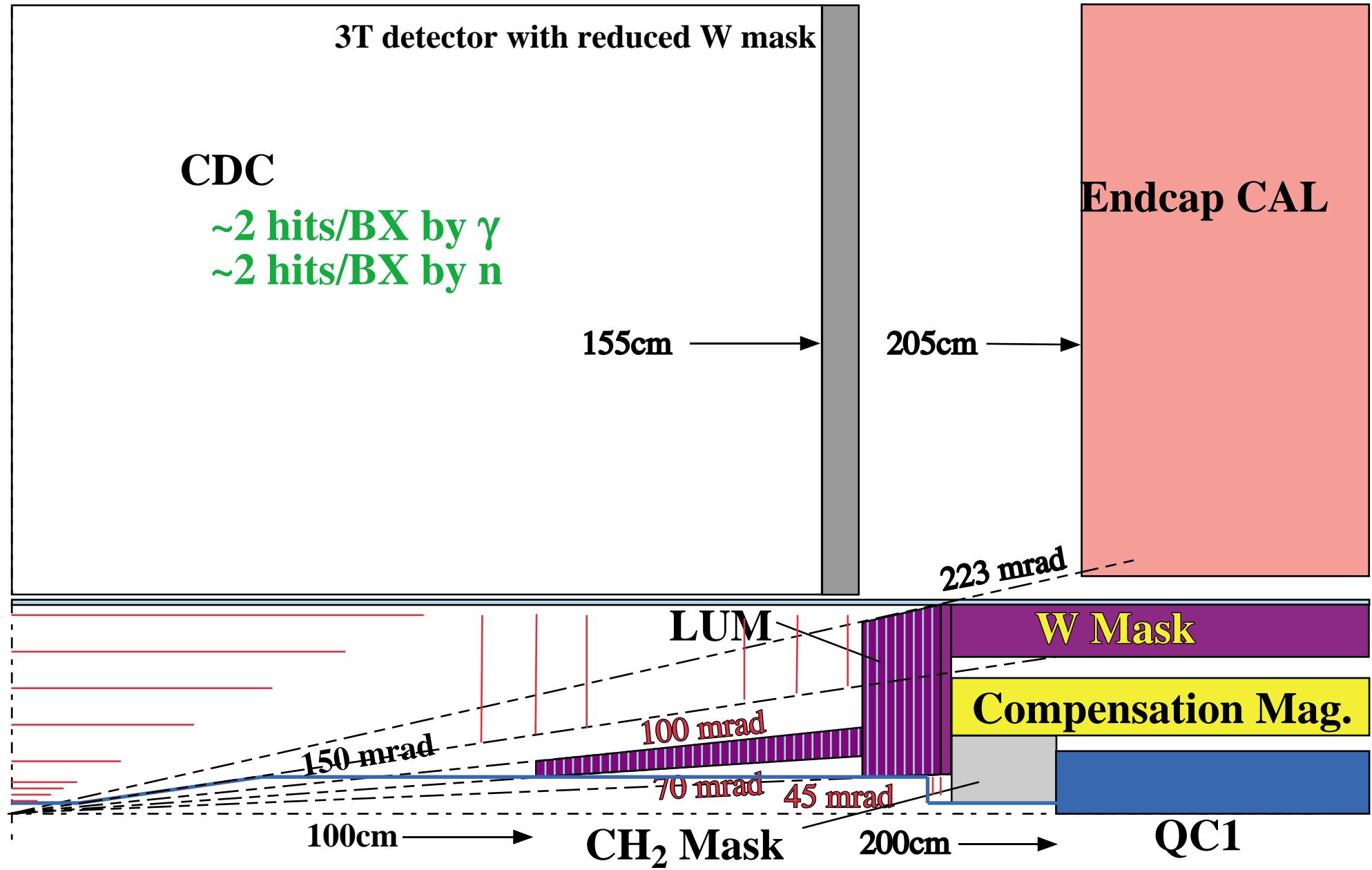
~ 2 hits/BX by γ
 ~ 30 hits/BX by n



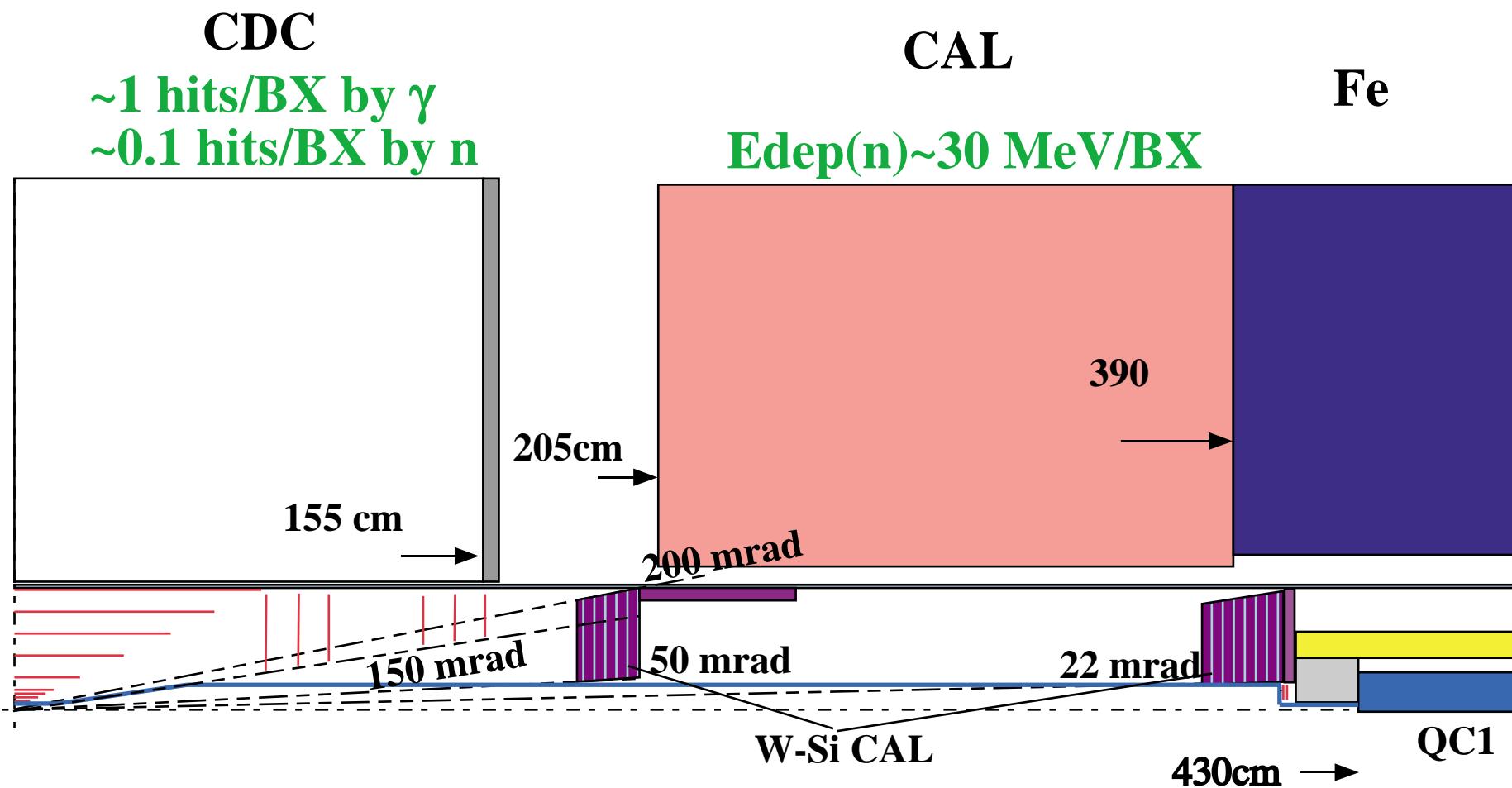
3T Detector



3T Detector



3T $l^*=4.3\text{m}$ Detector



Impact of the new optics ($l^*=4.3\text{m}$) on the detector

- Huge W-mask NOT needed
- Background hit much smaller (CDC, CAL)
- No need for Compensation magnet (?)
 - if the B field @4.3m is weak enough
 - or Super conducting QC1 is adopted
- Better forward coverage for calorimetry
- Smaller R_{\min} of CDC and CAL possible

Detector Model	CDC hits / BX (γ)	CDC hits / BX (n)	CAL Edep (GeV / BX) (γ)	CAL Edep (GeV / BX) (n)	θ_{\min} (mrad)
2T	2	30	~0	0.6	50
3T ($l^*=2\text{ m}$)	1	2	~0	0.9	50
3T ($l^*=4.3\text{ m}$)	1	0.1	0.01	0.03	22

Summary

- Steady progress in R&D for JLC detector -> “ACFA Report”
- But still “holes” in the study : Particle ID, Forward Tracker, etc.
- Other options (e.g. TPC for central tracker) should also be studied
- And still many things to do for TDR
- Pantaleo’s new F.F. optics is very attractive from the viewpoint of detector design
- Study on the new optics including the QC1 design is in progress